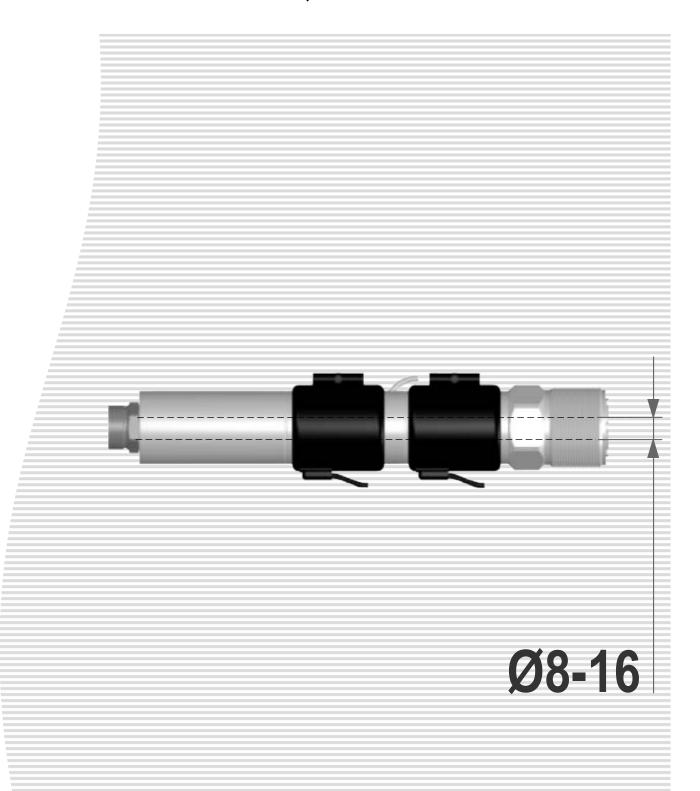
T16 Hot Runner Nozzle

Manifold Nozzles, Threaded











Product type

Hot runner nozzle, T (threaded)

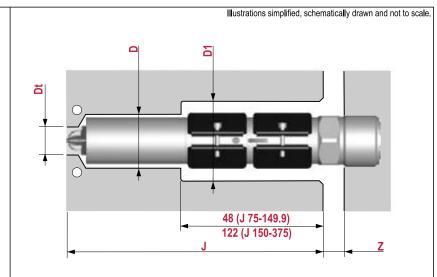
- → Manifold nozzle, threaded
- → Utilizes heat pipe technology to ensure uniform temperature
- → Patented seal technology
- → Replaceable threaded tips

Available with eight Controlled Vestige (CV) tip options including valve gates for zero vestige applications. See table at right.

Available gating types

- →Full flow
- → Cone point
- → Valve gate:

VG12 & VG23 tapered gate VG12S & VG23S Straight gate



Major Dimensions (mm)

J Nozzle length	75-375
Nozzle flow bore	Ø8-16
* D	Ø46
* D1	Ø68
Dt	Ø24
Z	18
L1	= 48 (J 75-149.9)
	= 122 (J 150-375)

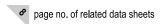
★ When the distance from the manifold center locator to the hot runner nozzle center line exceeds 650 the Ø46 clearance hole must be increased to Ø50 and the Ø68 hole increased to Ø72.

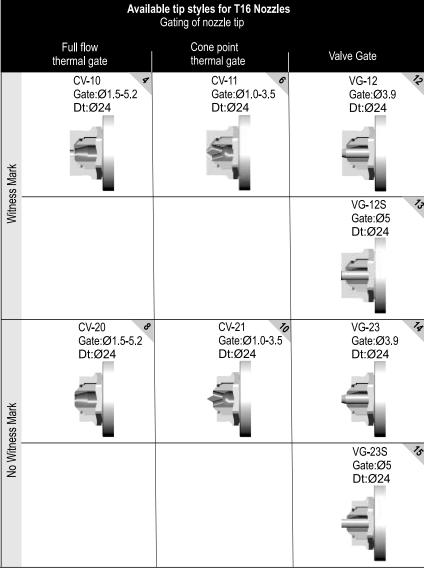
Heating

- →Externally heated, 240V/500W and 600W
- →One heater for operation
- →Installed spare heater and TC when space permits (J 150-375)

Application

→ Suitable for all filled and unfilled materials







Illustrations simplified, schematically drawn and not to scale.

1. Cut out for the nozzle

J Length from back of cavity plate to Gate location

General tolerances: DIN ISO 2768-mK

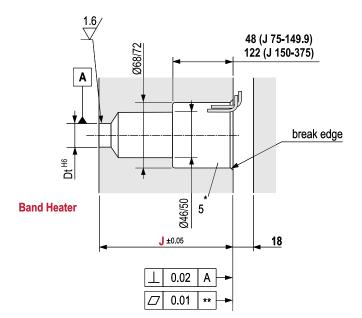
Surfaces:

 $\frac{3.2}{\checkmark}$ $\left(\begin{array}{cc} 1.6 / & 0.8 / \\ \checkmark & \checkmark \end{array}\right)$

Values of the dimension J can be found in the data sheet for the selected nozzle type.



- * drawn offset
- ** to all other pocket surfaces



4. Cut out for the nozzle tip

- A) Through bore nozzle tip (CV10, CV11, VG12 and VG12S
- b) Blind bore nozzle tip (CV20, CV21, VG23 & VG23S)

Dt Tip Ø

H Hot runner gate Ø

Depending on the selected nozzle type, different cut outs are required for the nozzle tip.

The dimensions of the cut out for the nozzle tip used can be found in the nozzle data sheet.

1) Applies to valve gate nozzles.

T16s Serie

T16 manifold criteria:

- →T16 hot runner systems do not require preload because they are threaded directly into the manifold.
- → The systems have a clearance between the thrust pads and mold plates in the cold condition. As the manifold heats and expands the thrust pads contact the plates.
- → Thrust pads are made of a low conductivity material and should only be replaced with an equivalent Synventive part
- → Excessive contact with the mold will cause heat sinks and affect system performance. Contact with the mold must be limited to specified areas.
- → Minimum rail height:

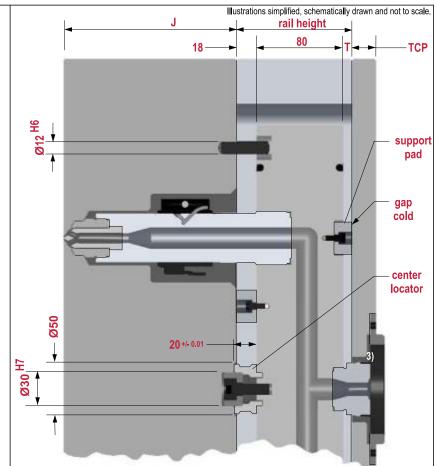
108 (thermal gates)

120 (valve gates)

→T:

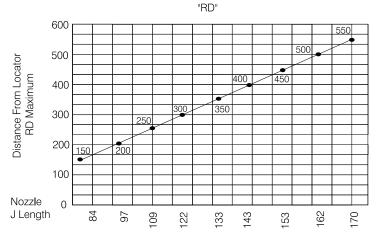
Rail height - 18 - 80 (thermal Gate) 22 (Valve Gate)

→ Minimum T (thermal gates) = 10



		-				
Variab l e		Description				
Т	Top Air Gap					
J		Mold Depth				
TCP		Top Clamp Plate				
T16 Maximum Radial Distance From Nozzle Centerline to Center Locator						
600		550				

- → Threaded nozzles line up with the gate locations in the mold in the cold condition. As the manifold heats and expands the nozzles flex. The distance from the center locator (RD) determines the amount of nozzle flex. The table to the right defines the maximum allowable distance from the nozzle to the center locator.
- → RD is the radial distance from the manifold center locator to the manifold nozzle center line.





General:

- → Filled and unfilled materials
- → Easy orifice changes by straight reaming
- → Heat pipes for isothermal operation

Nozzle Criteria:

- → Orifice Ø1.5-5.2
- → J length 75-375
- →Open flow bore
- → Patented seal

→ RD is the radial distance from the manifold center locator to the manifold nozzle center line.

T16 contour criteria:

- → When gating on an angled mold contour the vestige height may be increased depending on the angle
- → K is the increase in vestige height required to maintain a 1.6 wall, 6 wall and/or 4 minimum contact

θ≤6°;

K=0

E=12TANθ

L=2-(Ø Orifice/2)*ΤΑΝθ

6°<θ ≥26°:

K=4.2TANθ+1.6/COSθ-2

E=K+12TANθ

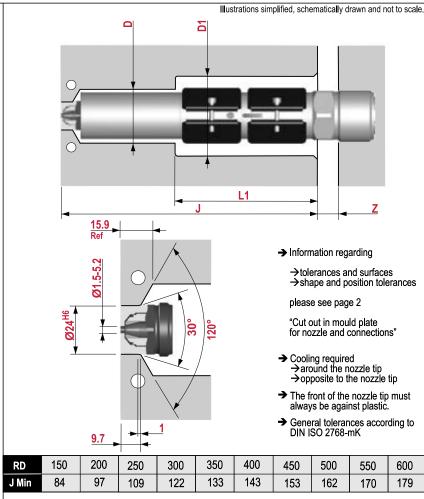
L=2+K-(Ø Orifice/2)*TANθ

θ>26°;

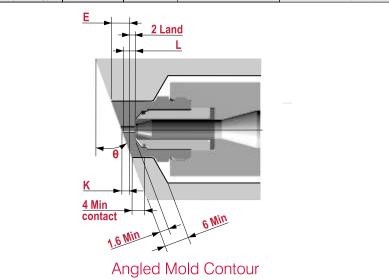
K=23TANθ-9.9

E=K+12TANθ

L=2+K-(Ø Orifice/2)*TANθ



Heater Style	J Min	J Max	Heater Qty	Watts/Volts
Band (38 long)	75	149.9	1	500W/240V
Band (51 long)	150	375	2 (one spare)	600W/240V (each)



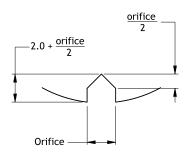


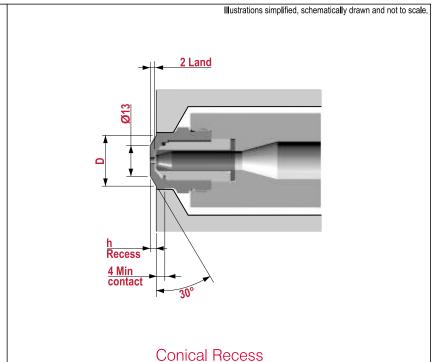
T16 recess criteria:

- → Values in tables are for materials not having glass fibers. Consult Synventive for vestige height when using glass fillers
- vestige height when using glass fillers

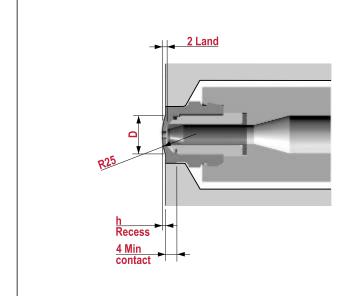
 → Recessed gates are used to reduce
 vestige height above the part surface or
 keep the vestige below the part surface
- keep the vestige below the part surface

 → For most materials CV10 vestige height is equal to 2 + (orifice Ø /2). If the vestige height, relative to the possible gate recess depth (h), is too great, use of a CV11 tip is recommended





h (recess depth)	1.0	1.5	2.0	2.5	3.0
D	16.5	18.2	19.9	21.7	23.4



Spherical Recess

h (recess depth)	1.0	1.5	2.0	2.5	3.0
D	14.0	17.1	19.6	21.8	23.8



General:

- → Filled and unfilled materials
- → More heat in gate area for semi-crystalline materials
- → Heat pipes for isothermal operation

Nozzle Criteria:

- → Orifice Ø1.0-3.5
- → J length 75-375
- → Patented seal

→ RD is the radial distance from the manifold center locator to the manifold nozzle center line.

T16 contour criteria:

- → When gating on an angled mold contour the vestige height may be increased depending on the angle
- → K is the increase in vestige height required to maintain a 0.13 land, 1.6 wall, 6 wall and/or 4 minimum contact

θ≤7°:

K=(Ø Orifice/2)*TANθ E=(24+Ø Orifice/2)*TANθ L=0.13

7°<θ ≥27°:

K=4.2TANθ+1.6/COSθ+ (Ø Orifice-1)/2*TANθ-2

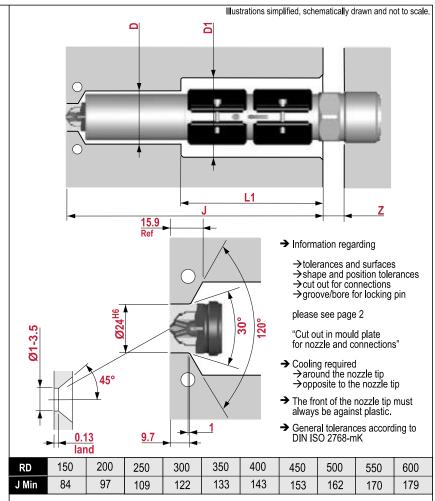
E=K+12TANθ

L=0.13+K-(Ø Orifice/2)*TANθ

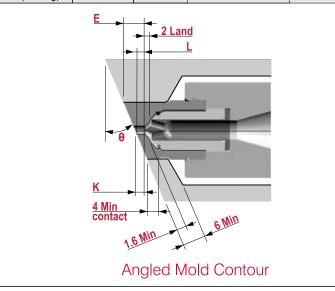
θ>26°;

K=23TANθ-9.9 E=K+12TANθ

L=0.13+K-(Ø Orifice/2)*TANθ



Heater Style	J Min	J Max	Heater Qty	Watts/Volts
Band (38 long)	75	149.9	1	500W/240V
Band (51 long)	150	375	2 (one spare)	600W/240V (each)

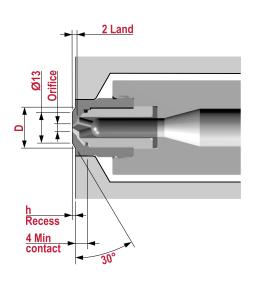




T16 recess criteria:

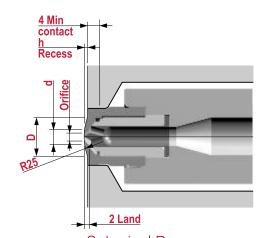
- → Values in tables are for materials not having glass fibers. Consult Synventive for vestige height when using glass fillers
- → Recessed gates are used to reduce vestige height above the part surface or keep the vestige below the part surface





Conical Recess

Orifice	1.0	1.5	2.0	2.5	3.0	3.5
h (recess depth)	0.59	0.76	0.93	1.09	1.26	1.43
D	15.04	15.63	16.22	16.78	17.36	17.95



٠.		
	Spherical	Recess

Orifice	1.0-1.2	1.2-1.4	1.4-1.6	1.6-1.8	1.8-2.0	2.0-2.2
h	0.65	0.72	0.79	0.86	0.93	1.00
d	1.45	1.65	1.85	2.05	2.25	2.45
D	11.33	11.91	12.47	13.00	13.51	14.00
Orifice	2.2-2.4	2.4-2.6	2.6-2.8	2.8-3.0	3.0-3.2	3.2-3.5
Н	1.06	1.12	1.18	1.26	1.32	1.40
d	2.65	2.85	3.05	3.25	3.45	3.65
D	14.41	14.80	15.18	15.67	16.03	16.50



General:

- → Filled and unfilled materials
- → Easy orifice changes by straight reaming
- → Heat pipes for isothermal operation
- → No witness mark on part
- → Easier removal of frozen material around tip for color change

Nozzle Criteria:

- → Orifice Ø1.5-5.2
- → J length 75-375
- →Open flow bore
- → Patented seal

→ RD is the radial distance from the manifold center locator to the manifold nozzle center line.

T16 contour criteria:

- → When gating on an angled mold contour the vestige height may be increased depending on the angle
- → K is the increase in vestige height required to maintain a 1.6 wall, 2 wall and/or 6 wall thickness

θ≤6°;

K=0

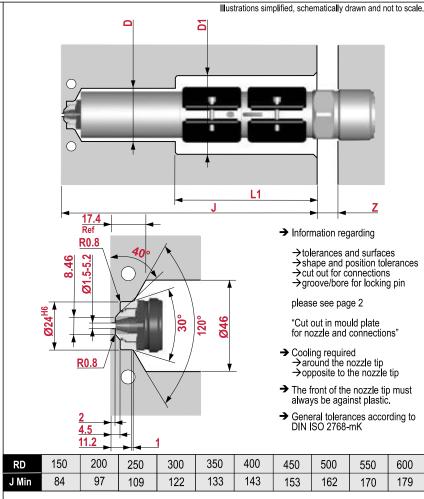
L=2-(Ø Orifice/2)*TANθ

6°<θ ≥16°;

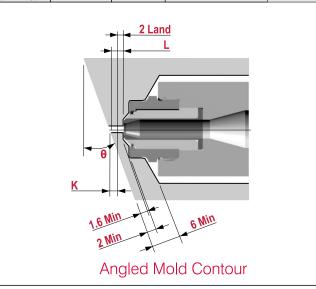
K=4.2TANθ+1.6/COSθ-2 L=2+K-(Ø Orifice/2)*TANθ

θ>16°;

K=12TANθ+2/COSθ-4.5 L=2+K-(Ø Orifice/2)*TANθ



Heater Style	J Min	J Max	Heater Qty	Watts/Volts
Band (38 long)	75	149.9	1	500W/240V
Band (51 long)	150	375	2 (one spare)	600W/240V (each)



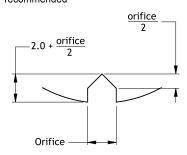


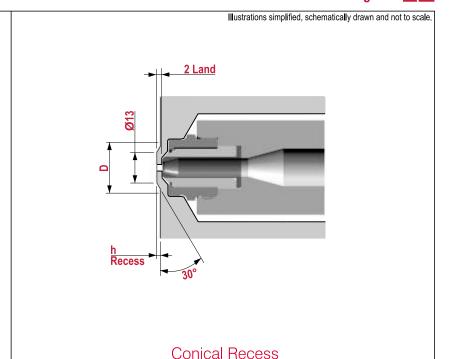
T16 recess criteria:

- → Values in tables are for materials not having glass fibers. Consult Synventive for vestige height when using glass fillers
- vestige height when using glass fillers

 → Recessed gates are used to reduce
 vestige height above the part surface or
 keep the vestige below the part surface
- keep the vestige below the part surface

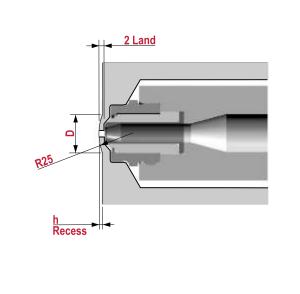
 → For most materials CV20 vestige height is equal to 2 + (orifice Ø /2). If the vestige height, relative to the possible gate recess depth (h), is too great, use of a CV11 tip is recommended





Cornodi Ficocos

h (recess depth)	1.0	1.5		
D	16.5	18.2		



Spherical Recess

h (recess depth)	1.0	1.5		
D	14.0	17.1		





General:

- → Filled and unfilled materials
- → No tip witness mark on part
- → More heat in gate area for semi-crystalline materials
- → Heat pipes for isothermal operation
- → Easier removal of frozen material around tip for color change

Nozzle Criteria:

- → Orifice Ø1 0-3.5
- → J length 75-375
- → Patented seal

→RD is the radial distance from the manifold center locator to the manifold nozzle center line.

T16 contour criteria:

- →When gating on an angled mold contour the vestige height may be increased depending on the angle
- → K is the increase in vestige height required to maintain 0.13 land, 2 wall and/or 7 minimum wall thickness

θ≤6°:

K=(Ø Orifice/2)/TANθ L=0.13

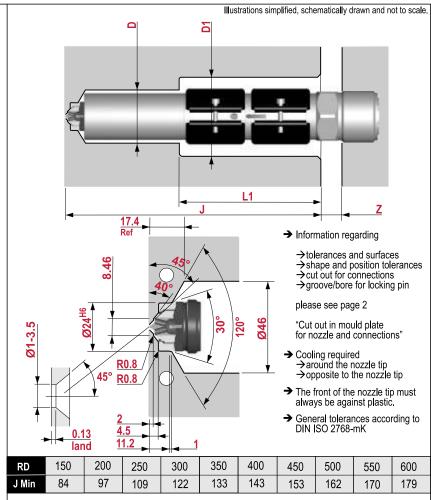
6°<θ ≥16°;

K=4.2TANθ+1.6/COSθ+ (Ø Orifice-1)/2*TANθ

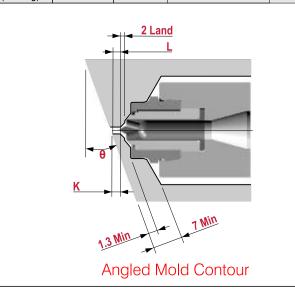
L=0.13+K-(Ø Órifice/2)*TANθ

θ>16°;

K=12TANθ+2/COSθ-4.5 L=.013+K-(Ø Orifice/2)*TANθ



Heater Style	J Min	J Max	Heater Qty	Watts/Volts
Band (38 long)	75	149.9	1	500W/240V
Band (51 long)	150	375	2 (one spare)	600W/240V (each)





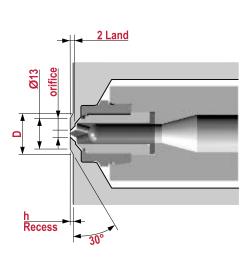
T16 recess criteria:

- → Values in tables are for materials not having glass fibers. Consult Synventive for vestige height when using glass fillers
- → Recessed gates are used to reduce vestige height above the part surface or
- keep the vestige below the part surface

 → Maintain 0.13 land when machining gate recess or contour

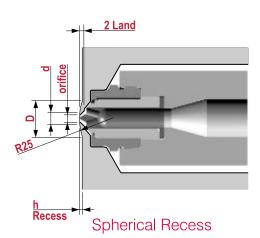


Illustrations simplified, schematically drawn and not to scale.



Conical Recess

Orifice	1.0	1.5	2.0	2.5	3.0	3.5
h (recess depth)	0.59	0.76	0.93	1.09	1.26	1.43
D	15.04	15.63	16.22	16.78	17.36	17.95



Orifice	1.0-1.2	1.2-1.4	1.4-1.6	1.6-1.8	1.8-2.0	2.0-2.2
h	0.65	0.72	0.79	0.86	0.93	1.00
d	1.45	1.65	1.85	2.05	2.25	2.45
D	11.33	11.91	12.47	13.00	13.51	14.00
Orifice	2.2-2.4	2.4-2.6	2.6-2.8	2.8-3.0	3.0-3.2	3.2-3.5
Н	1.06	1.12	1.18	1.26	1.32	1.40
d	2.65	2.85	3.05	3.25	3.45	3.65
D	14.41	14.80	15.18	15.67	16.03	16.50



T16 VG12

General:

- → Filled and unfilled materials
- → Tapered valve pin to eliminate gate flash
- → Heat pipes for isothermal operation

Nozzle Criteria:

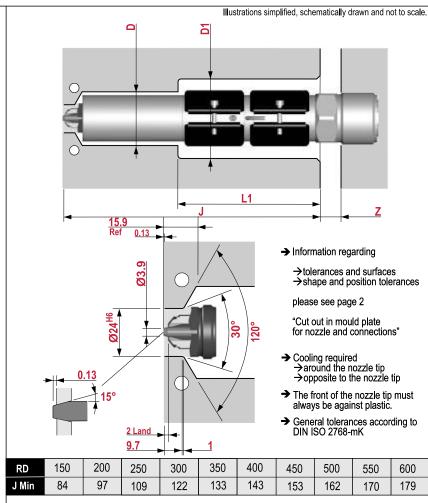
- →Orifice Ø3.9
- → J length 75-375
- → Patented seal

→RD is the radial distance from the manifold center locator to the manifold nozzle center line.

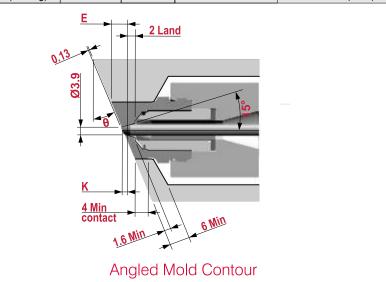
T16 contour criteria:

- → When gating on an angled mold contour the vestige height may be increased depending on the angle
- → K is the increase in vestige height required to maintain a 1.6 wall, 6 wall and/or 4 minimum contact

 $\theta \le 6^\circ$; K=0 $E=12*TAN\theta$ $6^\circ < \theta \ge 27^\circ$; $K=4.2TAN\theta+1.6/COS\theta-2$ $E=K+12TAN\theta$ $\theta > 27^\circ$; $K=23TAN\theta-9.9$ $E=K+12TAN\theta$



Heater Style	J Min	J Max	Heater Qty	Watts/Volts
Band (38 long)	75	149.9	1	500W/240V
Band (51 long)	150	375	2 (one spare)	600W/240V (each)





T16 VG12S

General:

- → Filled and unfilled materials
- → Straight valve pin for non-adjustable actuators and glass filled materials
- → Heat pipes for isothermal operation

Nozzle Criteria:

- →Orifice Ø5
- →J length 75-375
- → Patented seal

→ RD is the radial distance from the manifold center locator to the manifold nozzle center line.

T16 recess criteria:

- →When gating on an angled mold contour the vestige height may be increased depending on the angle
- → K is the increase in vestige height required to maintain a 1.6 wall, 2 wall and/or 4 wall thickness

θ≤6°;

K=0

E=12TANθ

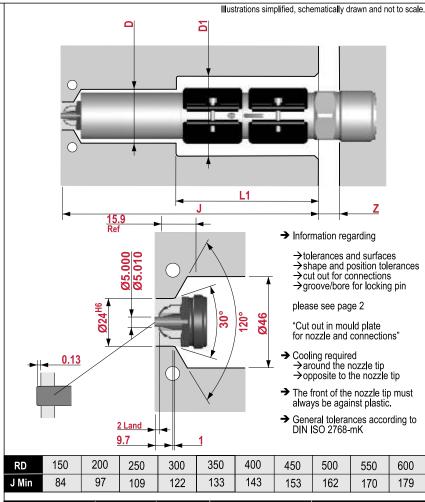
6°<θ ≥27°:

 $K=4.2TAN\theta+1.6/COS\theta-2$

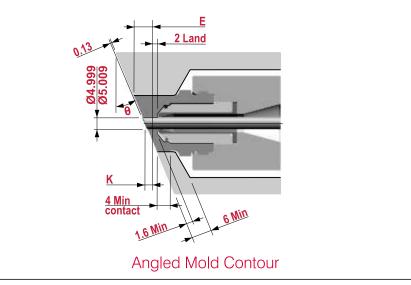
E=K+12TANθ

θ>27°;

K=23TANθ-9.9 E=K+12TANθ



Heater Style	J Min	J Max	Heater Qty	Watts/Volts
Band (38 long)	75	149.9	1	500W/240V
Band (51 long)	150	375	2 (one spare)	600W/240V (each)





T16 VG23

General:

- → Filled and unfilled materials
- → Tapered valve pin to eliminate gate flash
- → Heat pipes for isothermal operation
- → No witness mark on part

Nozzle Criteria:

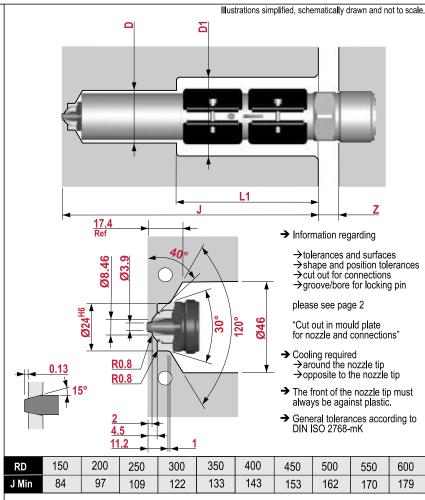
- →Orifice Ø3.9
- → J length 75-375
- → Patented seal

→ RD is the radial distance from the manifold center locator to the manifold nozzle center line.

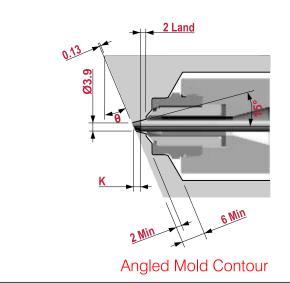
T16 recess criteria:

- → When gating on an angled mold contour the vestige height may be increased depending on the angle
- → K is the increase in vestige height required to maintain a 1.6 wall, 2 wall and/or 6 wall

 $\theta \le 6^{\circ}$; K=0 $6^{\circ} < \theta \ge 16^{\circ}$; K=4.2TAN θ +1.6/COS θ -2 $\theta > 16^{\circ}$; K=12TAN θ +2/COS θ -4.5



Heater Style	J Min	J Max	Heater Qty	Watts/Volts
Band (38 long)	75	149.9	1	500W/240V
Band (51 long)	150	375	2 (one spare)	600W/240V (each)





T16 VG23S

General:

- → Filled and unfilled materials
- → Tapered valve pin to eliminate gate flash
- → Heat pipes for isothermal operation

Nozzle Criteria:

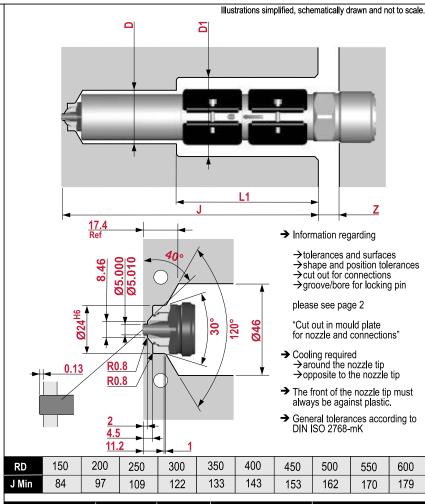
- →Orifice Ø3.9
- → J length 75-375
- → Patented seal

→RD is the radial distance from the manifold center locator to the manifold nozzle center line.

T16 contour criteria:

- → When gating on an angled mold contour the vestige height may be increased depending on the angle
- → K is the increase in vestige height required to maintain a 1.6 wall, 2 wall and/or 6 wall

 $\theta \le 6^{\circ}$; K=0 $6^{\circ} < \theta \ge 16^{\circ}$; K=4.2TAN θ +1.6/COS θ -2 $\theta > 16^{\circ}$; K=12TAN θ +2/COS θ -4.5



Heater Style	J Min	J Max	Heater Qty	Watts/Volts
Band (38 long)	75	149.9	1	500W/240V
Band (51 long)	150	375	2 (one spare)	600W/240V (each)

